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STW26NM60N Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit	
V _{DS}	Drain-source voltage	600	V	
V_{GS}	Gate-source voltage	±30	V	
I _D	Drain current (continuous) at T _C = 25 °C	20	Α	
I _D	Drain current (continuous) at T _C = 100 °C	12.6	Α	
I _{DM} ⁽¹⁾	Drain current (pulsed)	80	Α	
Ртот	Total dissipation at T _C = 25 °C	140	W	
dv/dt (2)	Peak diode recovery voltage slope	15	V/ns	
T _{stg}	Storage temperature range	FF to 150	°C	
Tj	Operating junction temperature range			

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	0.89	°C/W
R _{thj-amb}	Thermal resistance junction-ambient	50	°C/W

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
las	Single pulse avalanche current (pulse width limited by T_{jmax})	6	А
Eas	Single pulse avalanche energy (starting T _J =25 °C, I _D =I _{AS} , V _{DD} =50 V)	610	mJ

 $[\]ensuremath{^{(1)}}\mbox{Pulse}$ width limited by safe operating area.

 $^{^{(2)}}I_{SD} \leq 20~A,~di/dt \leq 400~A/\mu s,~V_{DS(peak)} \leq V_{(BR)DSS},~V_{DD} \leq 80\%~V_{(BR)DSS}$

2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified)

Table 5: On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	I _D = 1 mA, V _{GS} = 0 V	600			V
	Zoro goto voltago droin	V _{GS} = 0 V, V _{DS} = 600 V			1	
I _{DSS}	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 600 \text{ V},$ $T_{C} = 125 ^{\circ}\text{C}^{(1)}$			100	μA
I _{GSS}	Gate-body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$			±0.1	μΑ
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	2	3	4	V
R _{DS(on)}	Static drain-source on- resistance	V _{GS} = 10 V, I _D = 10 A		0.135	0.165	Ω

Notes:

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	1800	1	pF
Coss	Output capacitance	$V_{DS} = 50 \text{ V}, f = 1 \text{ MHz},$	-	115	ı	pF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0 V$	-	6	-	pF
Coss eq. (1)	Equivalent output capacitance	$V_{GS} = 0 \text{ V}, V_{DS} = 0 \text{ to } 480 \text{ V}$	-	310	-	pF
Qg	Total gate charge	$V_{DD} = 480 \text{ V}, I_D = 20 \text{ A},$	-	60	-	nC
Qgs	Gate-source charge	V _{GS} = 10 V	-	8.5	1	nC
Q_{gd}	Gate-drain charge	(see Figure 14: "Test circuit for gate charge behavior")	-	30	-	nC
Rg	Gate input resistance	f=1 MHz, I _D =0 A	-	2.8	-	Ω

Notes:

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 300 \text{ V}, I_D = 10 \text{ A},$	-	13	-	ns
tr	Rise time	R _G = 4.7 Ω , V _{GS} = 10 V (see Figure 13: "Test circuit for	-	25	-	ns
t _{d(off)}	Turn-off delay time	resistive load switching times"	-	85	-	ns
t _f	Fall time	and Figure 18: "Switching time waveform")	-	50	-	ns

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⁽¹⁾Defined by design, not subject to production test.

 $^{^{(1)}}$ Coss eq. is defined as a constant equivalent capacitance giving the same charging time as Coss when VDs increases from 0 to 80% VDs

Table 8: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		20	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		1		80	Α
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 20 A, V _{GS} = 0 V	-		1.5	V
t _{rr}	Reverse recovery time	$I_{SD} = 20 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$	-	370		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}$	-	5.8		μC
I _{RRM}	Reverse recovery current	(see Figure 15: "Test circuit for inductive load switching and diode recovery times")	•	31.6		А
t _{rr}	Reverse recovery time	I _{SD} = 20 A, di/dt = 100 A/μs	-	450		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, T_j = 150 \text{ °C}$	-	7.5		μC
I _{RRM}	Reverse recovery current	(see Figure 15: "Test circuit for inductive load switching and diode recovery times")	-	32.5		Α

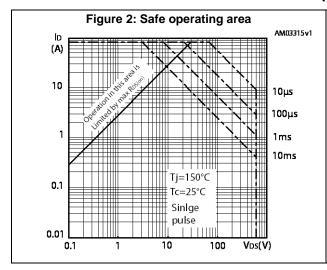
Notes:

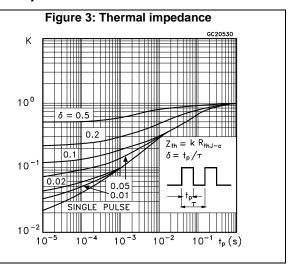


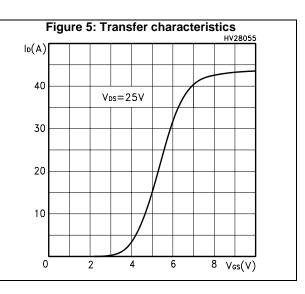
⁽¹⁾Pulse width limited by safe operating area.

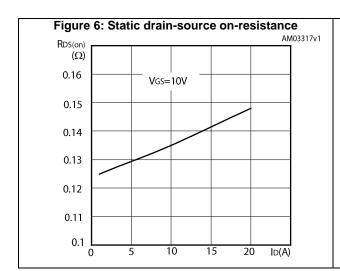
 $^{^{(2)}\}text{Pulsed:}$ pulse duration = 300 $\mu\text{s},$ duty cycle 1.5%

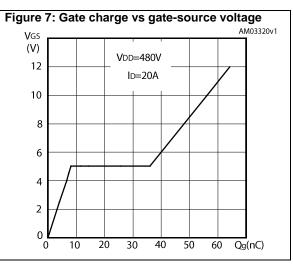
2.1 Electrical characteristics (curves)







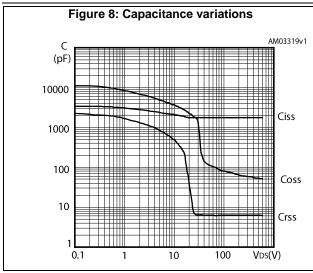




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STW26NM60N Electrical characteristics



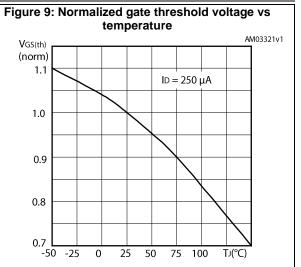
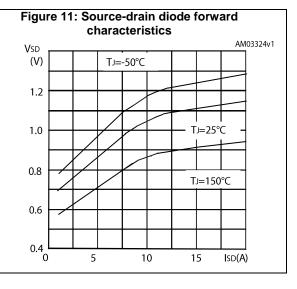
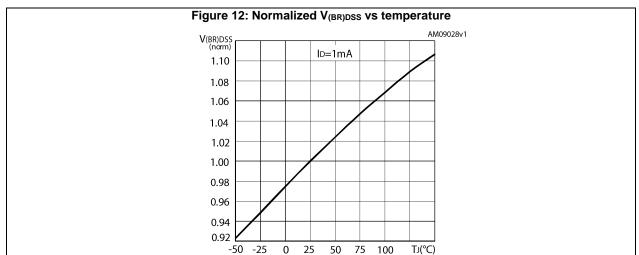


Figure 10: Normalized on-resistance vs temperature AM03322v1 RDS(on) (norm) 2.1 VGS = 10V1.7 1.3 0.9 0.5 -25 25 50 75 100 TJ(°C)







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Test circuits STW26NM60N

3 Test circuits

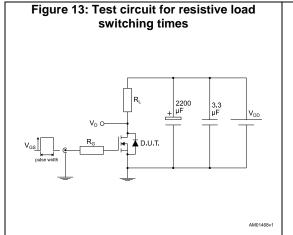


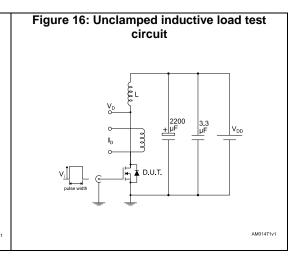
Figure 14: Test circuit for gate charge behavior

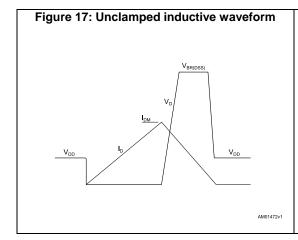
12 V 47 kΩ 100 nF D.U.T.

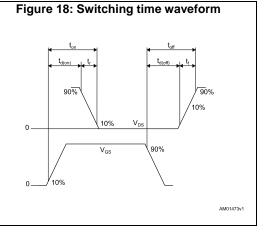
2200 PF 47 kΩ OVG

AM01469v1

Figure 15: Test circuit for inductive load switching and diode recovery times







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STW26NM60N Package information

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

4.1 TO-247 package information

HEAT-SINK PLANE S øR Ľ2 *b1 b2* BACK VIEW 0075325_8

Figure 19: TO-247 package outline

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Table 9: TO-247 package mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
А	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
С	0.40		0.80
D	19.85		20.15
Е	15.45		15.75
е	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70

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STW26NM60N Revision history

5 Revision history

Table 10: Document revision history

Date	Revision	Changes
07-Jul-2016	1	First release.
12-Dec-2016	2	Modified Table 6: "Dynamic" and Table 8: "Source-drain diode" Modified Section 2.1: "Electrical characteristics (curves)" Minor text changes

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